



COM#5-6 from IP211
& IP212 & IP217



Features

- Fanless system with IBASE MB230 customized board
- 9th/8th Gen Intel® Core™ i7/i5/i3 Desktop Processors
- Dual SIM slots supports WWAN redundancy
- 4x RJ45 Gigabit Ethernet port (2x supports 802.3at PoE+)
- 3x M.2 (B-key/E-key/M-key)
- Supports Over/Under/Reverse voltage protection
- iSMART, iAMT (11.6), TPM (2.0)
- 2x Flexible PCIe / PCI expansion slot
- 2x 2.5" storage (supports RAID 0/1)

Specifications

System Mainboard	MB230AF with Intel® Q370 PCH
CPU Type	9th/8th Gen Intel® Core™ i7/i5/i3 desktop processors
System Speed	Up to 4.0 GHz
Memory	2x DDR4-2666/2400 SO-DIMM, Max. 32GB
Front Panel External I/O	1x RS232/422/485 port for COM#1~COM#2 3x RS232 ports for COM#3~COM#4 2x RS232 ports for COM#5~6 from optional IP211/IP212 1x DisplayPort (1.2) 2x RJ45 Gigabit Ethernet port (supports 802.3at PoE+) 1x 5-pin DC-in terminal block for 12V (±10%) or 18V (-10%)~24V (+10%) 2x Antenna holes 2x USB 2.0 from optional IP211/IP212/IP213 2x Expansion slot
Rear Panel External I/O	1x DVI-D + HDMI(1.4) 4x USB3.1 ports 2x Antenna holes 2x RJ45 Gigabit Ethernet port + Dual USB3.1 stack ports 1x Red HDD LED 1x power button with Green LED indicator 1x 2-pin terminal block 2x SIM card
Expansion Slots	2x Flexible PCIe / PCI expansion slot 1x M.2 (B-key supports USB 2.0 for 4G/LTE) 1x M.2 (E-key supports PCIe + USB 2.0 for CNVi) 1x M.2 (M-key supports PCIe(4x) + SATA for NVMe SSD)
Storage	2x 2.5" HDD/SSD 1x M.2 (M-key supports PCIe(4x) + SATA for NVMe SSD)
Construction	Aluminum & steel
Chassis Color	Silver & Gray
Mounting	Desktop & wall mount
Dimensions	210mm (W) x 285mm (D) x 129mm (H) 8.27" (W) x 11.22" (D) x 5.08" (H)
Weight	4.9 kg
Operating Temperature	-20°C ~ 70°C (-4°F~158°F) (for 35W CPU)
Storage Temperature	-20°C~80°C (-4°F~176°F)
Relative Humidity	5~90% @60°C, (non-condensing)
Vibration	Operating: 3Grms / 5~500Hz
Shock	Operating: 20G / 11ms Non-operating: 40G / 11ms
Certification	CE/ FCC Class A/ LVD

Ordering Information

AMI232AFM (Supports Sierra module)	(AMI) Aluminum Chassis with MB230AF (Q370 PCH), Fanless Design, w/o CPU /memory/Storage/power adaptor. Supports 6x COM(from IP211/ IP212), 4x COM (from IP213), mounting brackets, optional riser card
AMI232-217M	(AMI) Aluminum Chassis with MB230AF (Q370 PCH), riser card(IP217). Fanless Design, w/o CPU/memory/ Storage/ power adaptor. Supports 4x COM, mounting brackets
330W Power Adaptor Kit (optional)	330W (24V@13.75A) power adaptor kit compatible with IEC62368-1/EN62368-1
Optional Accessories	Global 4G antenna kit for Sierra Wireless EM7565 module, M.2 (M-key 2280) Thermal kit

Dimensions and Drawing

